

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
SHIGERU ICHIHARA ET AL.) : Examiner: W. Leader
Application No.: 10/566,949) : Group Art Unit: 1795
Int'l Application No. PCT/JP2005/000732) : Confirmation No. 3062
Filed: January 14, 2005) :
For: PLATING SOLUTION, PROCESS)
FOR PRODUCING A STRUCTURE:
WITH THE PLATING SOLUTION,)
AND APPARATUS EMPLOYING :
THE PLATING SOLUTION) August 13, 2009

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

A. Introductory Comments

In response to the Office Action dated May 13, 2009, please amend the above-captioned application as follows and consider the following remarks.